Design and Testing of the AGS Booster BPM Detector*

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Abstract

The AGS Booster beam position monitor system must accurately measure the position of beams and bunches over a wide range of intensity. The frequency of operation must also cover a wide range (600 kHz to 4.2 MHz) since the Booster accelerates both protons and heavy ions. Split-cylinder electrodes were chosen to monitor the position of the beam because of their good low frequency response and high linearity. The need to accelerate low-energy partially-stripped heavy ions requires the pick-up electrodes (PUEs) to operate in a 3×10^{-11} torr vacuum. The PUEs are to measure the beam position to an absolute accuracy of ± 0.5 mm and must therefore be mechanically stable despite the requirement that they be vacuum fired at 950 °C and baked periodically to 300 °C. This presentation describes both the mechanical design of the PUEs and the automated test procedure used to ensure the stability, accuracy, and linearity of each unit.

I. DESIGN

Each capacitive detector is made from a diagonally split cylinder (Fig. 1). The position monitor also incorporates a calibration ring which couples equally to both electrodes. The ring provides a simulation of the electrical zero position that allows the monitor to be checked [1]. (See Fig. 1.)

Figure 1. Beam position monitor (longitudinal view).

The completely assembled position monitor must be vacuum-fired, i.e., heated in a vacuum, at 950 °C to remove dissolved hydrogen from the stainless steel components in order to achieve the desired 10^{-11} torr vacuum. Therefore a special design was required to support the components that permitted thermal expansion to occur without creating forces which could cause deformation or fracture. Stainless steel grows linearly by about 0.018 mm/mm when heated from room temperature to 950 °C. Hence, a stainless cylinder 127 mm in diameter and 127 mm long will grow approximately 2.3 mm in diameter and length. Spring material could not be used because at 950 °C, the stiffness coefficient of even high temperature spring material decreases by 90%.

In addition to accommodating the large thermal expansion, the various components must be electrically isolated from one another. The dielectric material needs to have the following properties: very low outgassing and very low porosity, ability to withstand vacuum firing to 950 °C, and good structural strength. High-density alumina, a ceramic containing more than 92% Al_2O_3 , is suitable. The thermal growth of alumina, however, is about half that of stainless steel over the same temperature range, so in the design, the stainless always surrounds the alumina so that the stainless grows away from the alumina as the temperature increases.

Figure 2. Double-gimbal beam position monitor.

Fig. 2 shows the arrangement of the four outer ceramic tubes which provide the gimbal support of the calibration ring from the outer shell. The four inner ceramic pins support the split-cylinder assembly from the calibration ring and thereby from the outer shell as well. Because all the support members are located in a plane perpendicular to the longitudinal (beam) centerline, expansion and contraction of the components can

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occur freely in the longitudinal direction without inducing any loading on other components or on the ceramic supports. Radial movement is accommodated by the gimbal support between the outer shell and the calibration ring and between the calibration ring and the split-cylinder assembly. Differential radial expansion between any of the three cylindrical components, outer shell, calibration ring, or split-cylinder assembly, is accommodated by a radial sliding motion between either of the metal components and the ceramic supports without imposing loads on any of the components.

In addition to accommodating thermal movement, the design maintains the alignment of the components, including concentricity. The gimbal support insures that concentricity will be maintained even when thermal gradients produce relative dimensional changes.

To obtain the required accuracy of the location of the components, diametral clearances between the ceramic pins and tubes and their corresponding holes were limited to <0.03 mm. In order to permit assembly of the gimbals, the holes themselves had to be located with an similar accuracy. It was also necessary to fully anneal the stainless steel components before machining, and in some cases to stress relieve them prior to finish machining, in order to minimize distortion resulting from machining stresses or from the 950°C vacuum firing. Any distortion during firing can cause binding at the gimbal connections which, in turn, imposes loads on the adjacent stainless and ceramic components that can result in damage to, or failure of, one or more components.

To maintain the required gap between the halves of the diagonally-cut cylinder while holding them together as a unit for gimbal mounting, it was necessary to fasten them together semi-rigidly while maintaining electrical isolation between the plates as shown in the Fig. 3. Two ceramic pins span the gap at opposite ends. Although little differential thermal growth was anticipated, the stainless steel angles to which the ceramic pins are attached flex to allow for any small changes in the gap during heating.

The plates of the detector are fabricated from a cylinder which was machined from fully annealed stainless tube stock.

The cylinder was then stress relieved and the gimbal mounting holes added. The two pairs of holes are offset, so that once the halves are separated by the desired gap, the holes are co-planar. Even though it is a relatively slow process, electric discharge cutting was used so that no machining stresses were introduced into the part.

Figure 3. Split-cylinder assembly.

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II. TEST

A. Description

After the split-cylinder pick-up electrodes and the associated calibration ring have been carefully assembled, the unit is inserted into the pick-up electrode body or shell. The pick-up electrode body is itself part of the vacuum chamber. It has openings for the four coaxial signal feed-throughs as well as mounting holes to allow the BPM to be precisely positioned in the Booster quadrupoles.

In order to allow the split cylinder to be inserted into the outer shell, one end is left open until it is welded to the flange that reduces the diameter of the chamber to that which passes through the quadrupoles. As a consequence, one of the halves of the split cylinder does not see the electrical environment it sees after being installed. Therefore, it is necessary to attempt to produce an electrically similar configuration. This is done by using a short extension.

After the extension has been attached, the detector is positioned vertically on a stand. Short rods are inserted into the same mounting holes which allow the BPM to be precisely mounted in the quadrupoles. These rods accurately position the detector on the mounting stand and prevent it from moving.

In order to obtain the scan measurement data, a signal wire is dropped through the inside of the pick-up electrode body. The wire (a 0.25-mm diameter piano wire) is connected to a $180\ \Omega$ terminating resistor and is then placed under tension produced by a strong spring. The signal wire is strung between the two arms of a large C-shaped support. The C-shaped support itself is mounted to the platform of an X/Y Cross Table (Techno Model HL32SBM2298).

A program running on a Hewlett Packard 9836S workstation/instrument controller automates the measurement process. The primary measuring instrument is the HP3577A Network Analyzer. The RF output port of the HP3577A provides the signal, and the A and B receiver ports measure the r.m.s. voltage on the each half of the split-cylinder of the pick-up electrode assembly. The equipment used is schematically indicated in Figure 4.

Figure 4. Set-up for the scanned wire measurements.

The X/Y Table Controller is attached to one of two RS-232C interfaces on the workstation. A complete scan consists of 261 measurements. By convention, the plane of highest sensitivity is designated y . The aperture is scanned at five x positions ($-50, -30, 0, +30, +50$). At each of the x positions, a measurement is taken every 2 mm from $y = -50$ mm to $y = +50$ mm (51 measurements). In addition to these 255 measurements, the wire is moved to (0,0) between each x position scan and at the beginning and the end of the entire measurement process, thus giving 6 additional measurements at position (0,0).

For each of the 261 measurements, the Network Analyzer takes 401 measurements each of the r.m.s. magnitude of the voltage of the signals at its A and B receivers. (These 401 measurements are called a "trace.") The program retrieves these values and computes the average, the difference between the maximum and minimum measurement, and the standard deviation for the two signals. These three values for each

channel are stored on flexible discs along with the coordinates of the wire position.

B. X/Y Table Accuracy

The X/Y Cross Arm Table is an economical model and can not provide a continuous indication of its position. In fact, the table controller only knows when the platform has reached a single location on each of the axes, and this single location must be at one of the extremes of the arm movement. The controller knows that this position has been reached by the opening of a micro-switch when a protrusion mounted to the platform contacts it. All positions are then relative to the position of the platform when the switches on each axis opens (the "Home" position). The controller sends pulses to the two stepper motors to drive a lead screw which in turn moves the platform relative to the Home position. There are 100 half-steps per mm.

When the table is commanded to Home, the platform moves at the programmed acceleration until the switches are struck. The manufacturer specifies the accuracy of the homing operation to be ± 0.01 mm. In addition to this error must be added the inaccuracy of determining the position of the mechanical center of the detector as mounted on the stand relative to the Home position.

The center of the stand (relative to the Home position) is determined by use of a special centering fixture. The centering fixture is mounted on the stand in place of the detector. The signal wire is dropped through a small hole in the fixture and made taut. Two micrometers are mounted over the center hole on a vertical bar. The deviation of the center of the wire—the wire has a radius of about 5 mils—from the true center is determined using the micrometers. The vertical mounting of two micrometers allows the C-shaped support to be adjusted to make the wire perpendicular to the stand. After the wire has been centered along one axis and made perpendicular in that plane, the centering fixture is rotated 90° and the procedure is repeated for the other axis. When the centering was repeatable to ± 0.08 mm, it was deemed acceptable.

In addition to the difficulty of centering the wire, there was initially some jitter in the movement of the table platform itself. It was determined that this was due to either a bowing of the lead screw or to a loose fit that allowed the platform to tilt first to one side and then the other as it progressed along the lead screw. The effect was seen in the plots of the deviation of the data from a straight line where it manifested itself as a periodic variation instead of a smooth curve. This problem was solved by dismantling the entire X/Y Table and reassembling it with attention being given to making everything tight.

C. Results

Immediately after the data have been taken and stored, it is analyzed. All the results are plotted and a robust straight line fit is made to each of the five data sets (one for each of the five x positions) for the points which falls within -30 mm $< y < +30$ mm [2]. The fits are two-parameter fits (slope and offset) of $(V_A - V_B)/(V_A + V_B)$ as a function of the programmed y position, where V_A and V_B are the magnitudes of the voltages on plates A and B of the PUE, respectively. A final fit is performed for the same range of y values, but combining all the points in this range for the three central x scans ($-30, 0, +30$).

Figure 5. Typical scan wire measurement results.

The deviations from a straight line are plotted in all cases. Typical results are shown in Fig. 5.

Sixty detectors have been measured. (Forty-six are required for the Booster and six more are needed for the transfer line from the Booster to the AGS.) The average value for the slope, K , was 90.75 at 5 MHz. The standard deviation was 0.20, but the K value for each individual detector will be used by the Booster Beam Position Monitoring System. The offset, O , averaged -0.26 mm. All but three detectors had negative offsets. This is believed to result from the inability of the extender to fully simulate the electrical environment of the detector as it is after the shell has been welded to the next section of the vacuum chamber. Therefore, the offsets that are automatically acquired during operation by the Booster control software will be used instead [3].

III. ACKNOWLEDGMENTS

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IV. REFERENCES

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